

Model RFP-20-100RP

F Power

Flanged Resistors 20 Watts, 100Ω



Features

- DC 4.0 GHz
- 20 Watts
- **BeO** Ceramic .
- Welded Silver Leads
- Non-Nichrome Resistive Element
- 100% Tested

Outline Drawing

General Specifications

Resistive Element:	-
Substrate:	I
Cover:	1
Mounting Flange:	(
	(
Lead(s):	ę

Thick film Beryllium oxide ceramic Alumina ceramic Copper, nickel plated per QQ-N-290 99.99% pure silver (.005" thk)

Electrical Specifications

Resistance Value:	1
Frequency Range:	[
Power:	2
Capacitance:	-

100 ohms ±5% DC - 4.0 GHz 20 Watts 1.2 pF

Notes: Tolerance is ±.010, unless otherwise specified. Operating temperature is -55°C to +150°C (see chart). Designed to meet or exceed applicable portions of MIL-E-5400. All dimensions are in inches. Lead length 0.15" minimum.

Specifications subject to change without notice.

116 DIA. THRU. .062 250 .125 .125 050 TYP 515 RFP 20-100 -125-RP .150 MAX.

VER. 12/5/01

Sales Desk USA: Voice: (800) 544-2414 Fax: (315) 432-9121 Sales Desk Europe: Voice: (+44) 23 92 232392 Fax: (+44) 23 92 251369

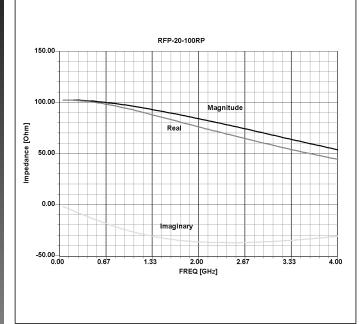


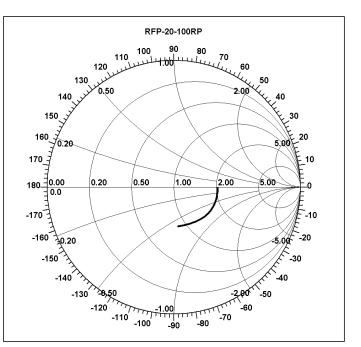
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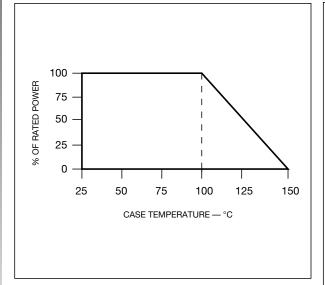


Typical Performance

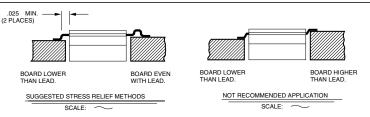




Power Derating



Suggested Mounting Procedures



- 1. Make sure that the devices are mounted on flat surfaces (.001" under the device) to optimize the heat transfer.
- 2. Drill & tap the heatsink for the appropriate thread size to be used.
- 3. Coat heatsink with a minimum amount of high quality silicone grease (.001" max. thickness).
- 4. Position device on mounting surface and secure using socket head screws, flat & split washers. Torque screws to the appropriate value. Make sure that the device is flat against the heatsink. (Care should be taken to avoid upward pressure of the leads towards the lid).
- 5. Solder leads in place using an SN63 type solder with a controlled temperature iron (210°C).



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